Abstract Submitted for the MAR16 Meeting of The American Physical Society

Silicon-nitride photonic circuits interfaced with monolayer MoS2<sup>1</sup> TEODOR K. STANEV, GUOHUA WEI, NATHANIEL P. STERN, Department of Physics and Astronomy, Northwestern University, DAVID A. CZAPLEWSKI, IL WOONG JUNG, Center for Nanoscale Materials, Argonne National Laboratory — Monolayers of transition metal dichalcogenides exhibit interesting low-dimensional opto-electronic phenomena and large optical interactions. Harnessing these features for modulating light requires interfacing these monolayer semiconductors with photonic devices. Here, we show the integration of monolayer molybdenum disulphide (MoS<sub>2</sub>) with silicon nitride ring microresonators using a visco-elastic layer transfer <sup>2</sup>. Cavity transmission is used to measure the coupling of the monolayer evanescently coupled to the ring resonator. A linear absorption coefficient of 850 dB/cm is observed in this geometry, which is larger than that of graphene and black phosphorus with the same thickness. These assembly methods can be applied to a diverse catalog of monolayer materials for assembling hybrid optoelectronic devices over a wide spectral range.

<sup>1</sup>This work is supported by the DOE-BES (DE-SC0012130), ISEN, and the Center for Nanoscale Materials, DOE-BES (DE-AC02-06CH11357). N.P.S. is an Alfred P. Sloan Research Fellow.

<sup>2</sup>G. Wei, T. K. Stanev, D. A. Czaplewski, I. W. Jung, and N. P. Stern. *Appl. Phys. Lett.* **107**, 091112 (2015)

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Date submitted: 06 Nov 2015

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